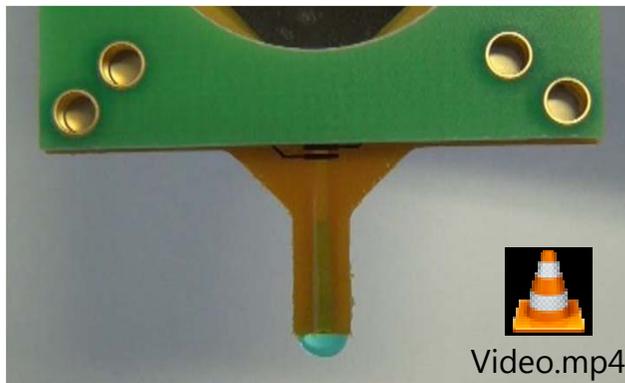


---

# Integration of CNT-based actuators for bio-medical applications

Example printed circuit board CNT actuator pipette

---



Fraunhofer IPA, Germany  
AIST Kansai, Japan

**Besoncons, France**  
**11.07.2014**

Raphael Addinall  
Raphael Neuhaus

# Fraunhofer IPA as part of the Fraunhofer-Gesellschaft

## Europe's largest applied research organization



**Fraunhofer Institute  
for Manufacturing Engineering  
and Automation IPA**

- One of the largest single institutes of the Fraunhofer-Gesellschaft
- More than 50 years of experience
- Competent at implementing innovations into industry



# German-Japanese Cooperation

**Fraunhofer Institute for  
Manufacturing  
Engineering and  
Automation (IPA)**

Department Functional  
Materials

**AIST Kansai  
National Institute of  
Advanced Industrial  
Science and Technology  
(AIST)**

Research Institute for Cell  
Engineering



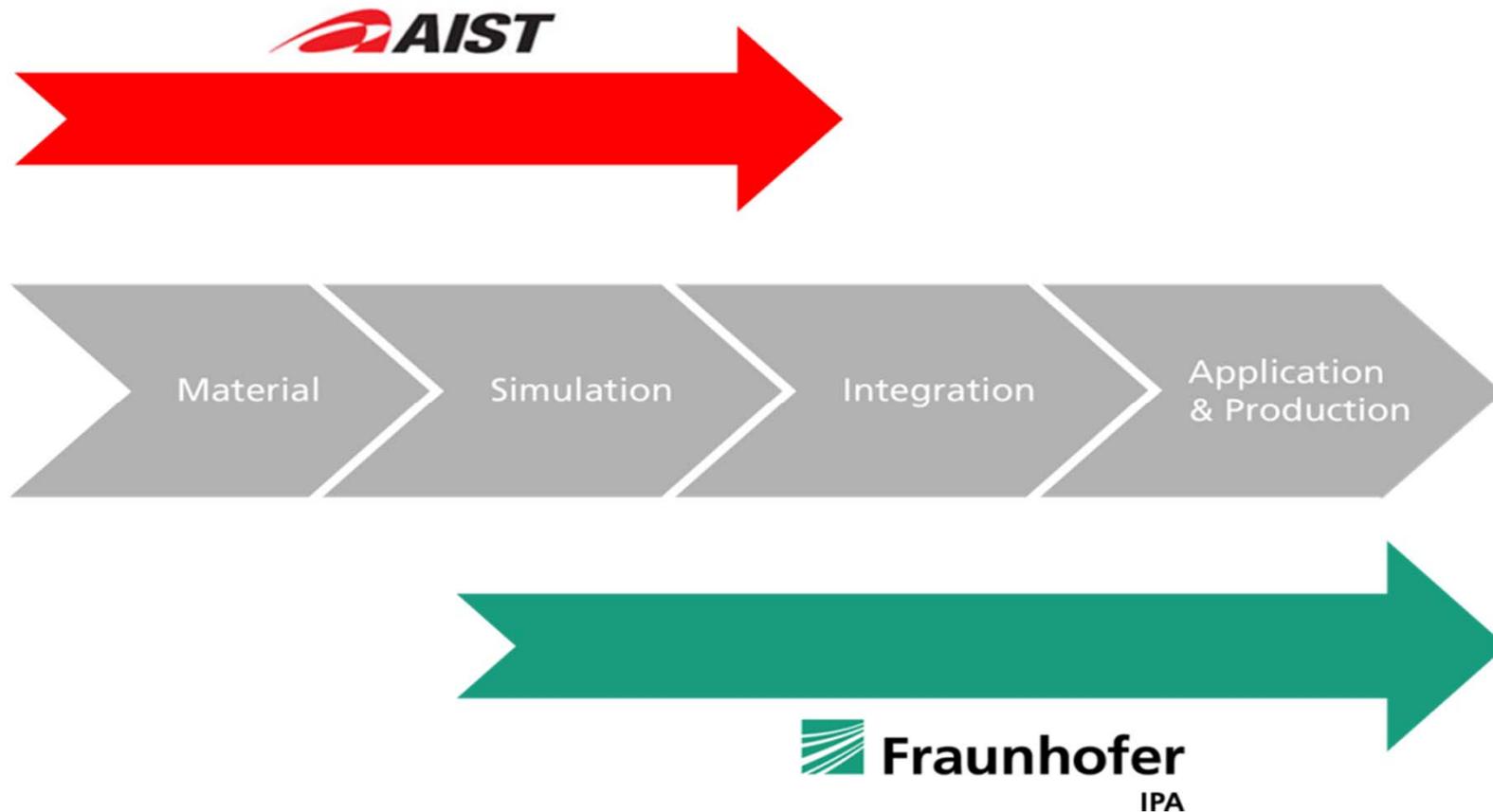
Picture source: <http://cio-perspectives.com>

3



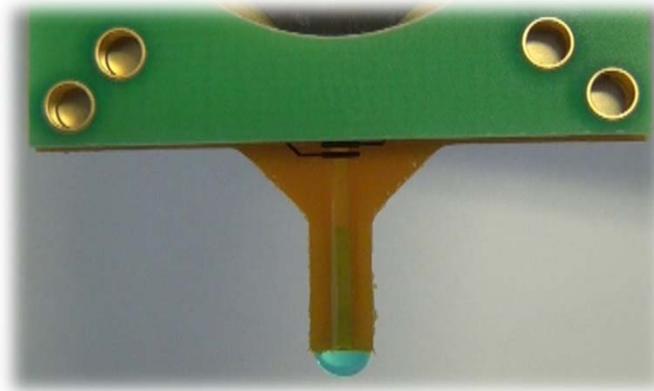
# Complementary Workflow of AIST and Fraunhofer IPA

## Sharing and complementing Expertise



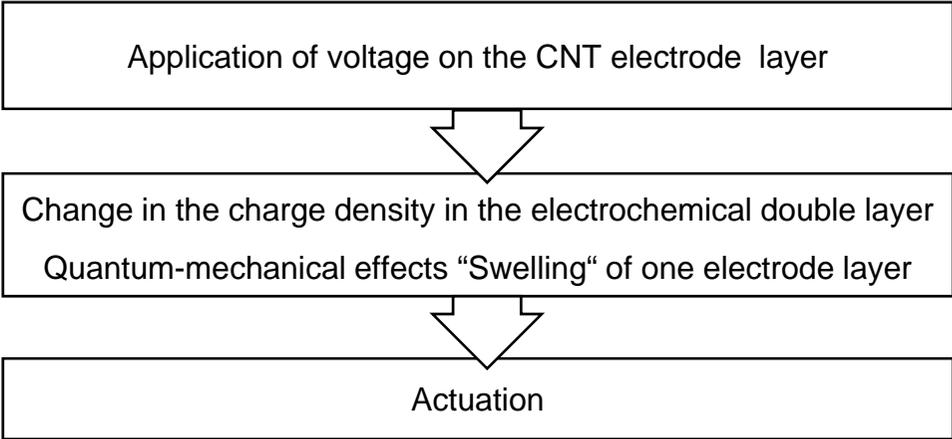
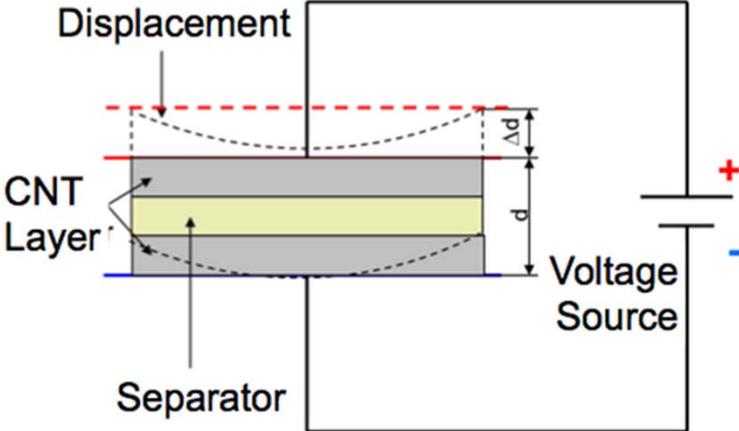
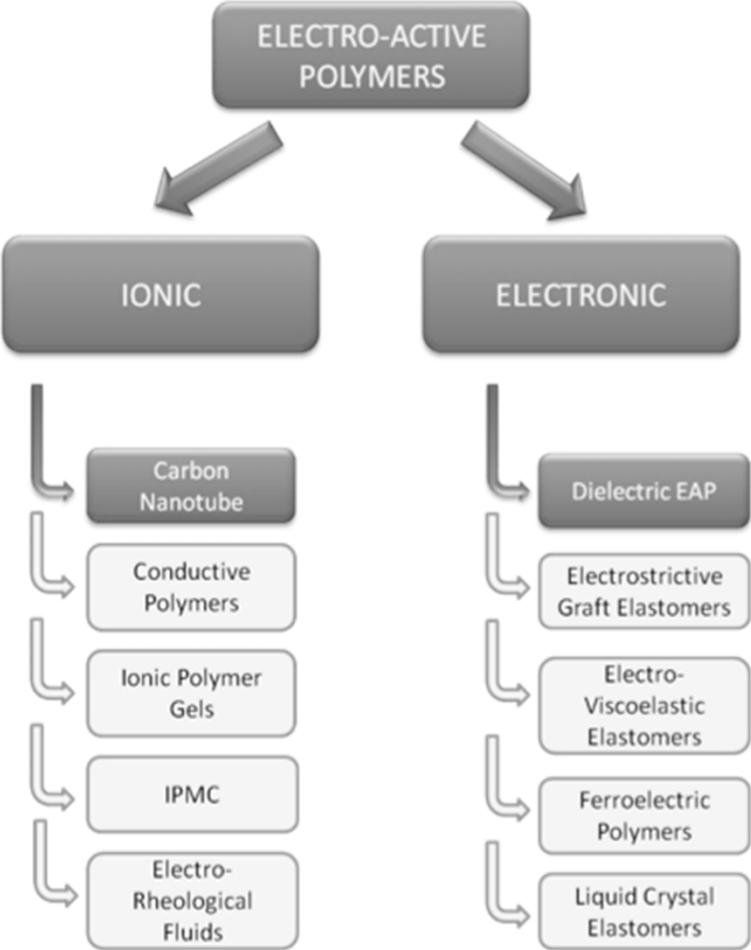
# Overall aim of our collaboration

- **The need for integration:**
  - use actuator technology in a specific application
- **Exploring the design space and optimization:**
  - Finite element simulation of actuators – compare and predict actuator behaviour
- **Production technology:**
  - Both printed circuit boards and actuators



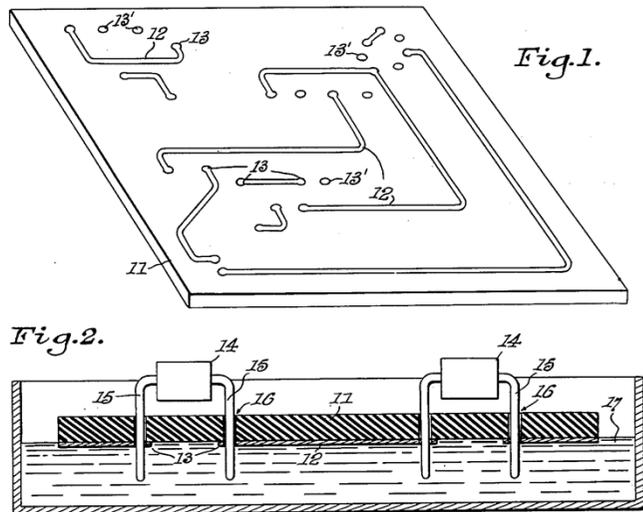
5

# Actuators



# Printed Circuit Board (PCB) Technology

July 31, 1956 M. ABRAMSON ET AL 2,756,485  
PROCESS OF ASSEMBLING ELECTRICAL CIRCUITS  
Filed Aug. 28, 1950



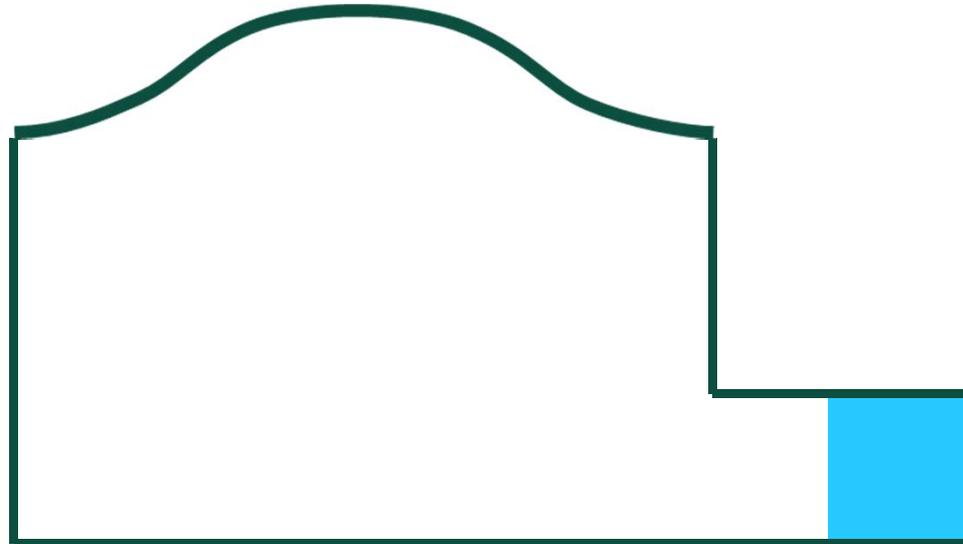
First patent-1956, M. Abramson et AL

- Standardized interfaces (mechanical/electrical)
- Standardized production
- Easy handling
- Easy integration of driver electronics
- Integrated electrodes and connection leads

7

# Principle: Displaced Volume

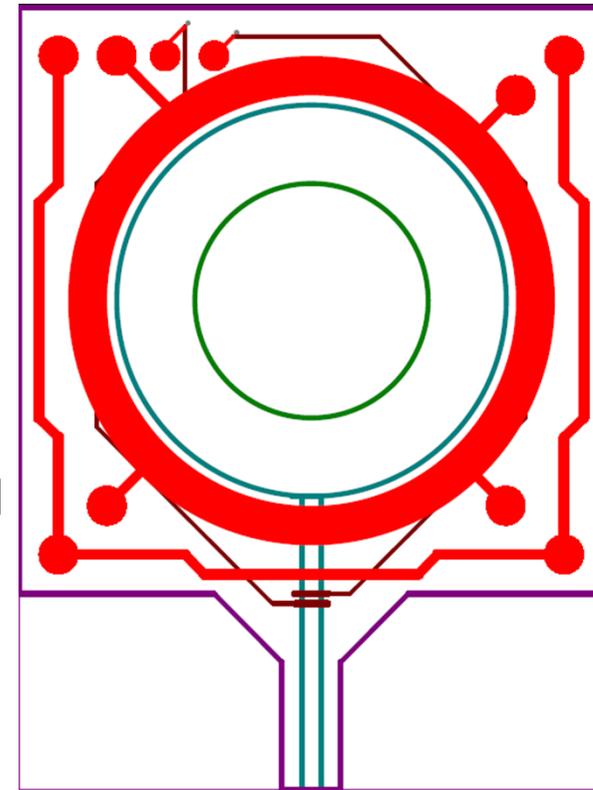
Overall aim



Design aim for actuation:  $> 100 \mu\text{m}$  in center,  $> 10 \mu\text{l}$  displacement

# CAD PCB Design

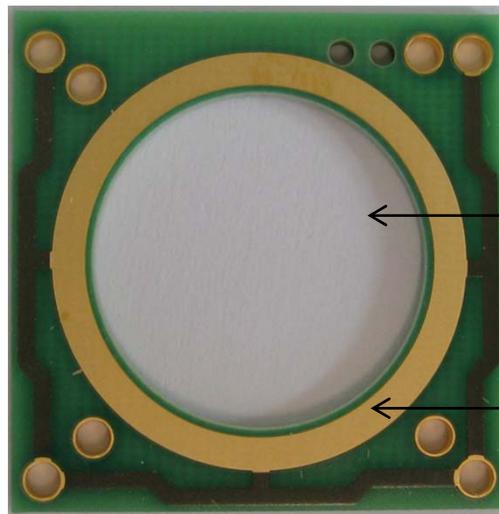
- 2D CAD design on several layers
- Layer stack:
- PCB boards made of standard FR4 material
- 50  $\mu\text{m}$  polyimide foil or PTFE



		Verpressen	Material	Position / Film	
			Deckfolie		63
T			Cu: 18 $\mu$ -> 35 $\mu$		35
			Polyimid: AP8525		50
B			Cu: 18 $\mu$ -> 35 $\mu$		35
			Noflowpreg		50
			FR4 Kern 1,5mm		1500
<b>Arbeitsablauf:</b>					<b>Kürzel:</b>

Source of layer stack: Contag AG, Berlin

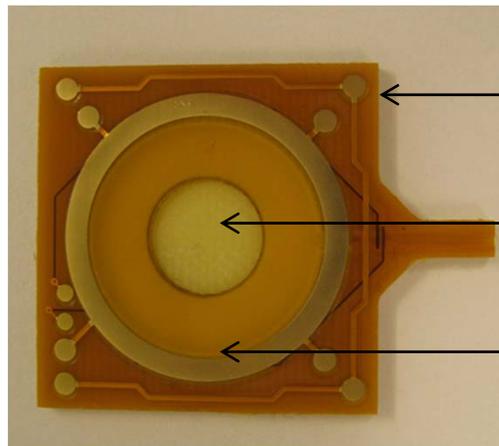
# Printed circuit board (PCB) Design



← Holes/vias with and without metallisation

← Mill any inner geometry

← Etch any electrical trace geometry into copper

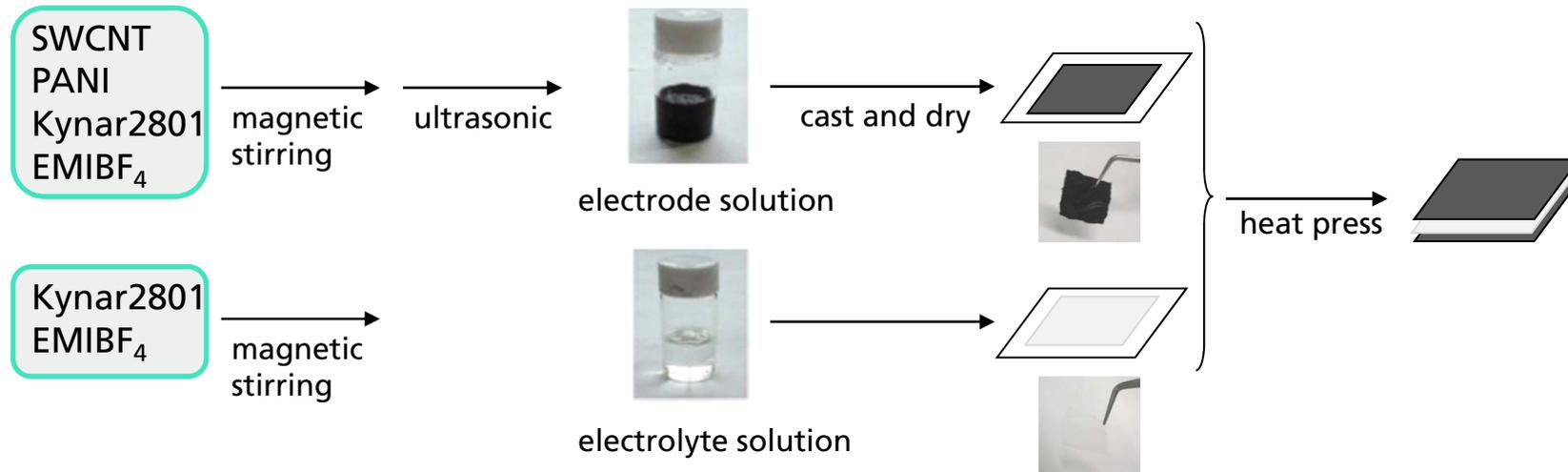


← Nickel/gold plating

← Lower stiff layer

← Flexible Membrane ring

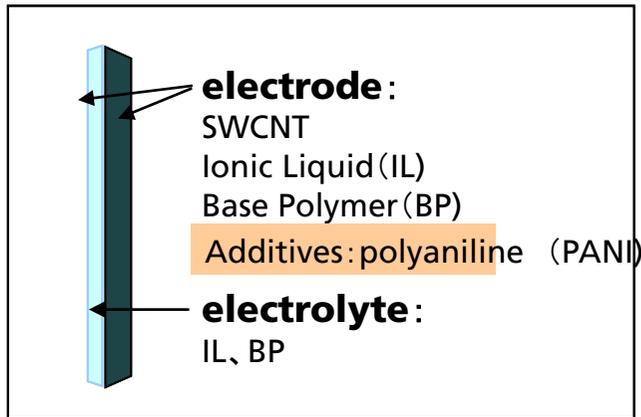
# Fabrication process of the three-layered actuator



## 【Characteristic data of PANI】

20 wt% polyaniline on carbon black  
particle size: ca. 40 nm  
conductivity: 40 S/cm  
BET surface area= 690 m<sup>2</sup>/g

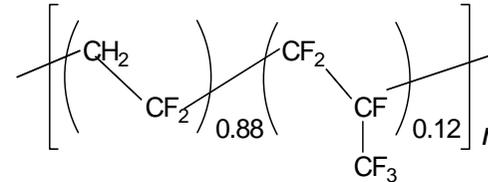
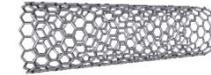
## 【Structure of nanocarbon polymer actuators (three-layered) and components】



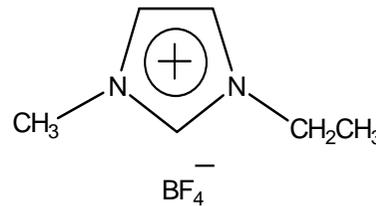
- stable and long-life actuation **in air**
- low voltage drive (within  $\pm 3V$ )
- easy fabrication by a casting method

SWNTs: Single-walled carbon nanotubes by HiPco method

BP: PVDF-HFP(kynar2801)



IL: EMIBF<sub>4</sub>



### Electrode:SWCNT/PANI(50/50)-2IL

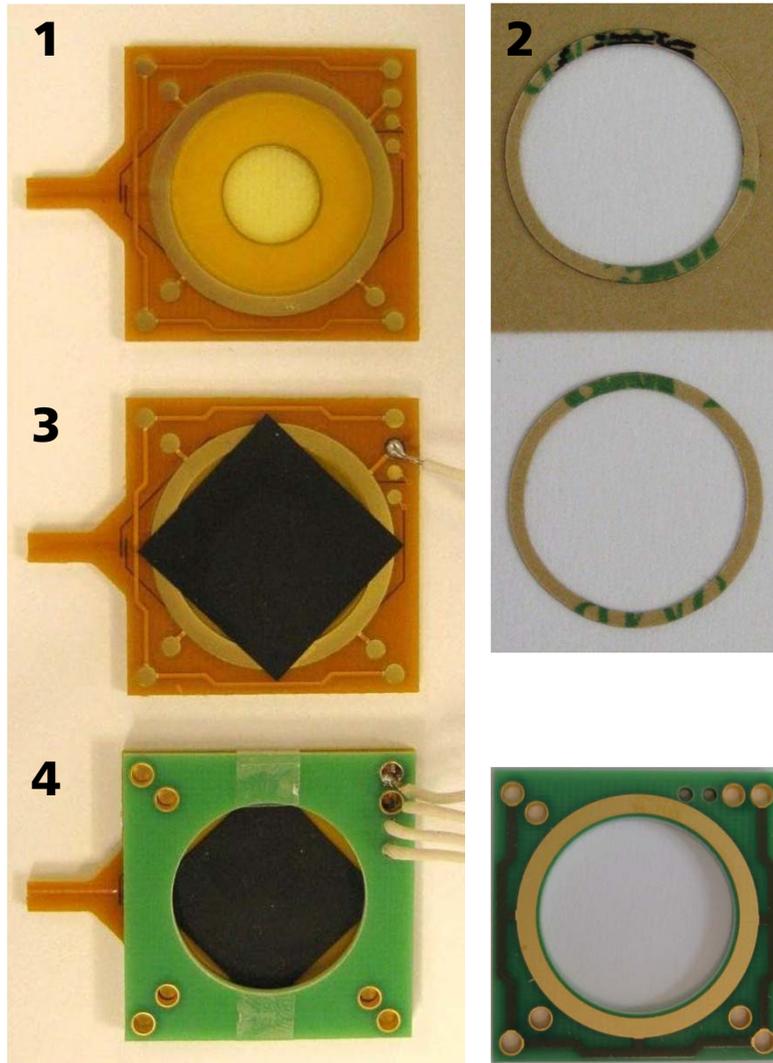
components: **SWCNT/PANI**/kynar2801/EMIBF<sub>4</sub>=**50.7 mg/50.6 mg**/80.6 mg/240.9 mg  
 (11.99 wt%/11.97 wt%/19.06 wt%/56.98 wt%)

### Electrolyte: kynar2801/EMIBF<sub>4</sub>

components: kynar2801/EMIBF<sub>4</sub>=200.4 mg/200.1 mg  
 (50.04 wt%/49.96 wt%)

12

# Integration & connection methods



## Mechanical:

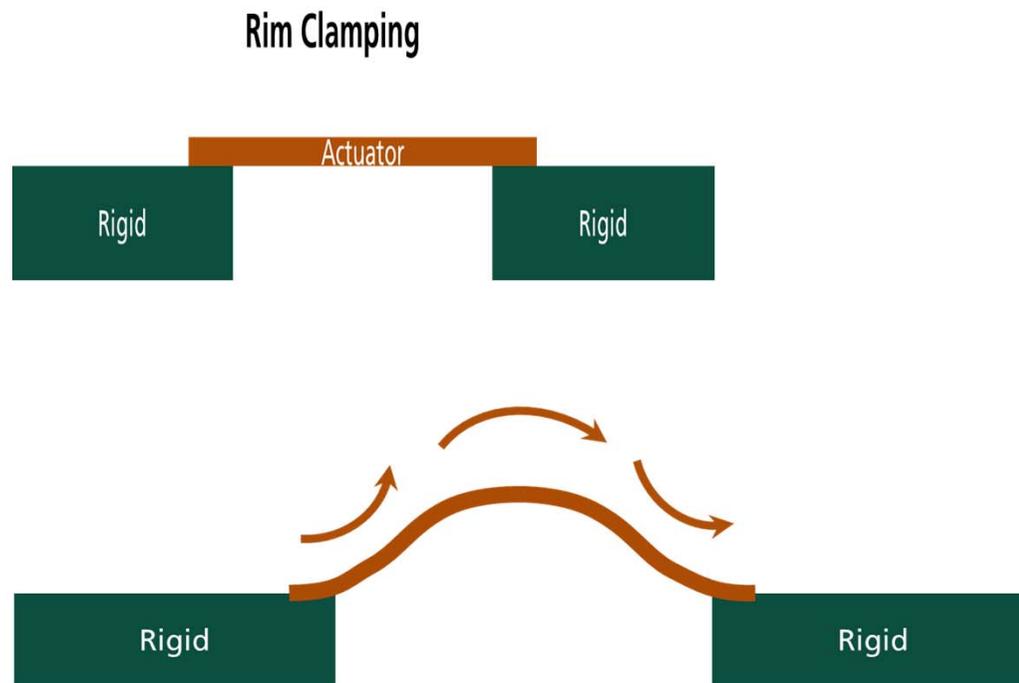
- Gluing (Epoxy, „super glue“, etc.)
- Tape (3M Double sided) laser cut

## Electrical:

- Soldering, Reflow soldering
- Conductive glues or glue tapes
- Non-standard: Low temperature solders
- Clamping with top electrode (PCB)

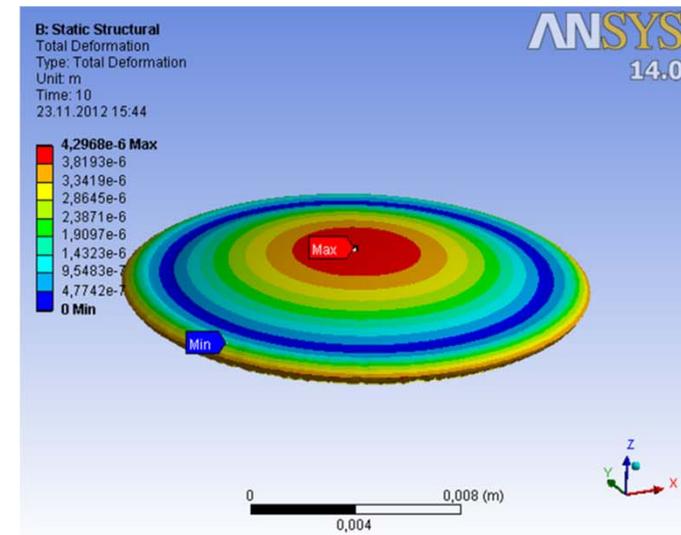
13

# Positioning of actuator to PCB (no soft intermediate layer)



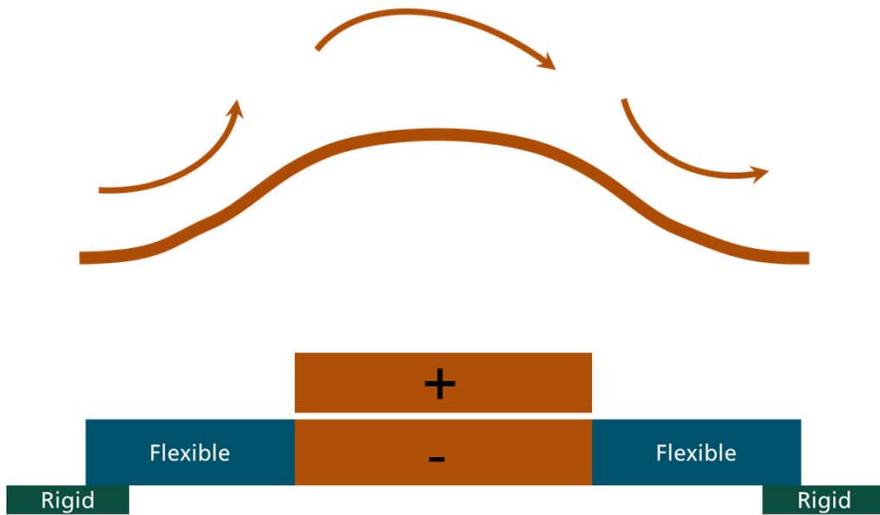
Rim Clamping: Non-constant Curvature

Soft to hard - rim clamped actuator

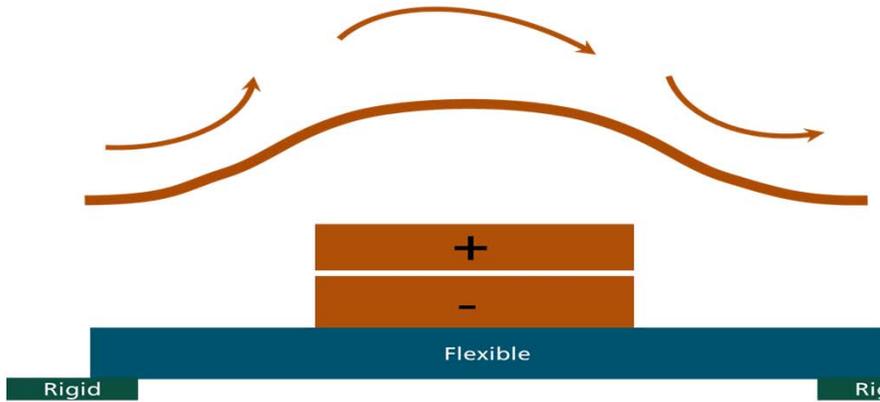


# Positioning of actuator to PCB (with soft intermediate layer)

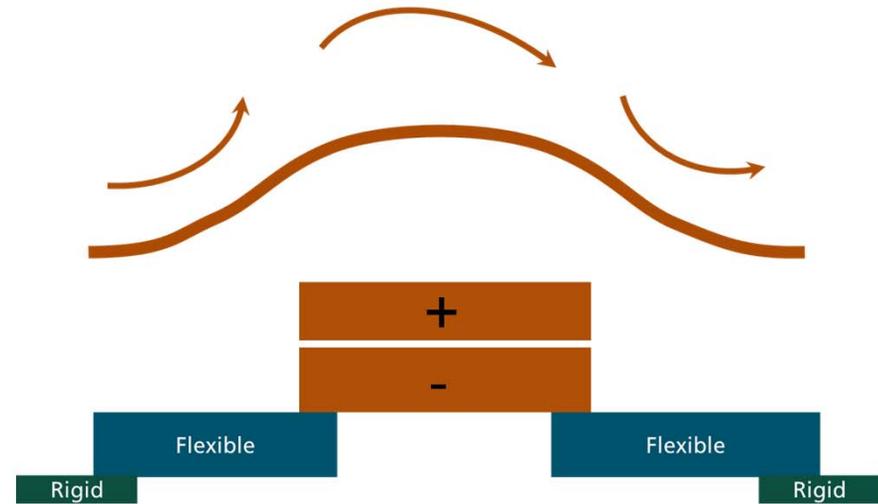
Setup with Passive Flexible Layer



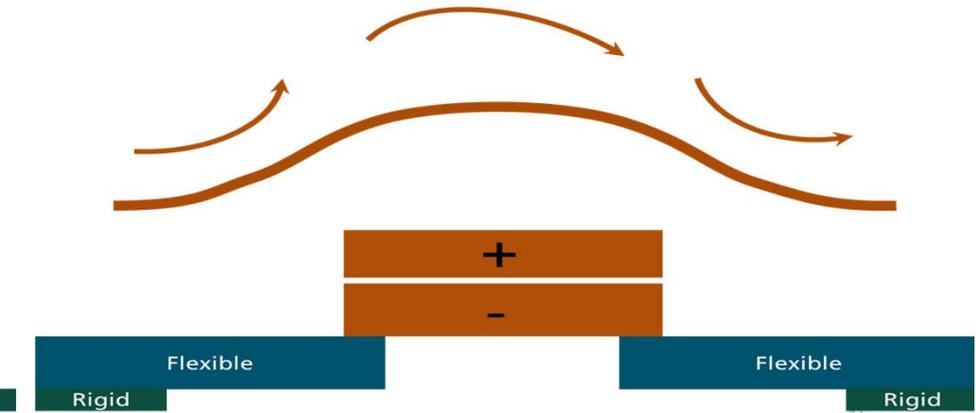
Closed Membrane Setup



Setup with Passive Flexible Layer 2



Open Membrane Setup



# Tensile Test Data and Digital Material Models

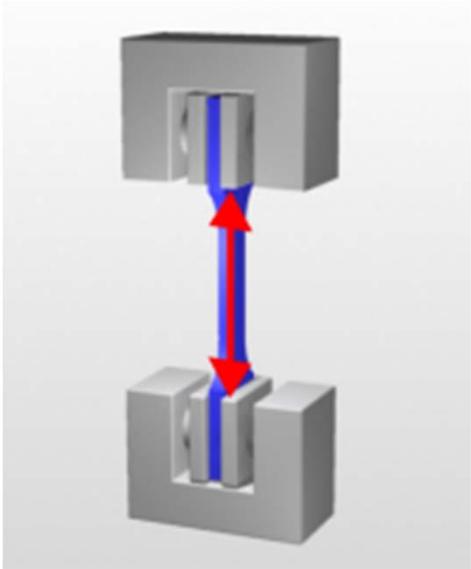
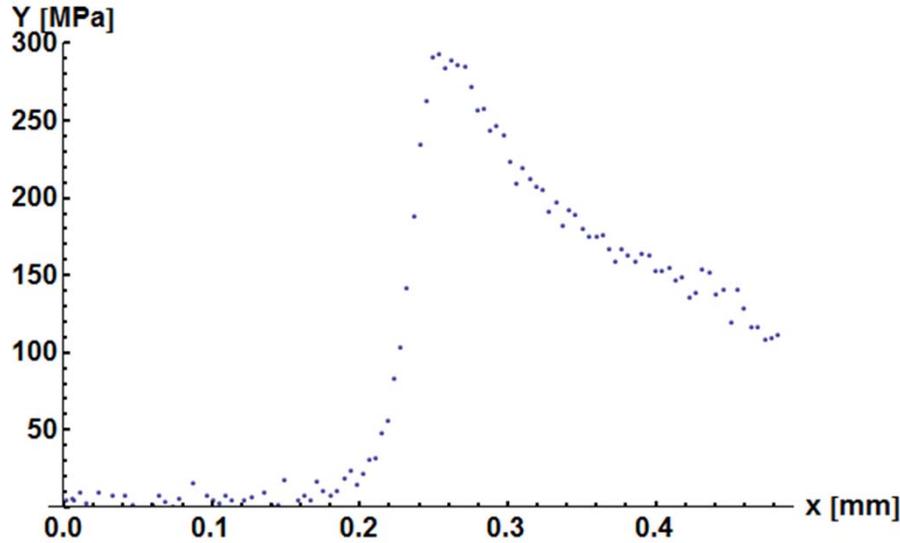
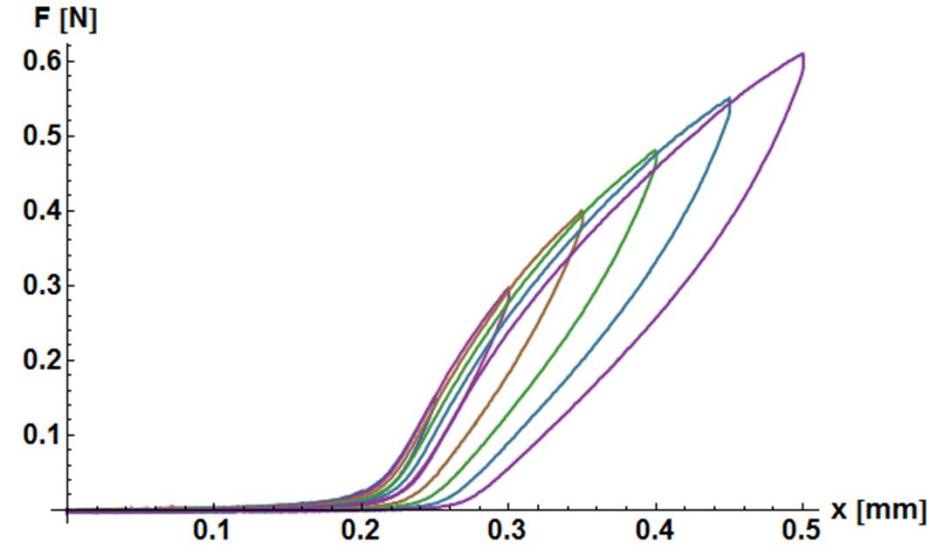
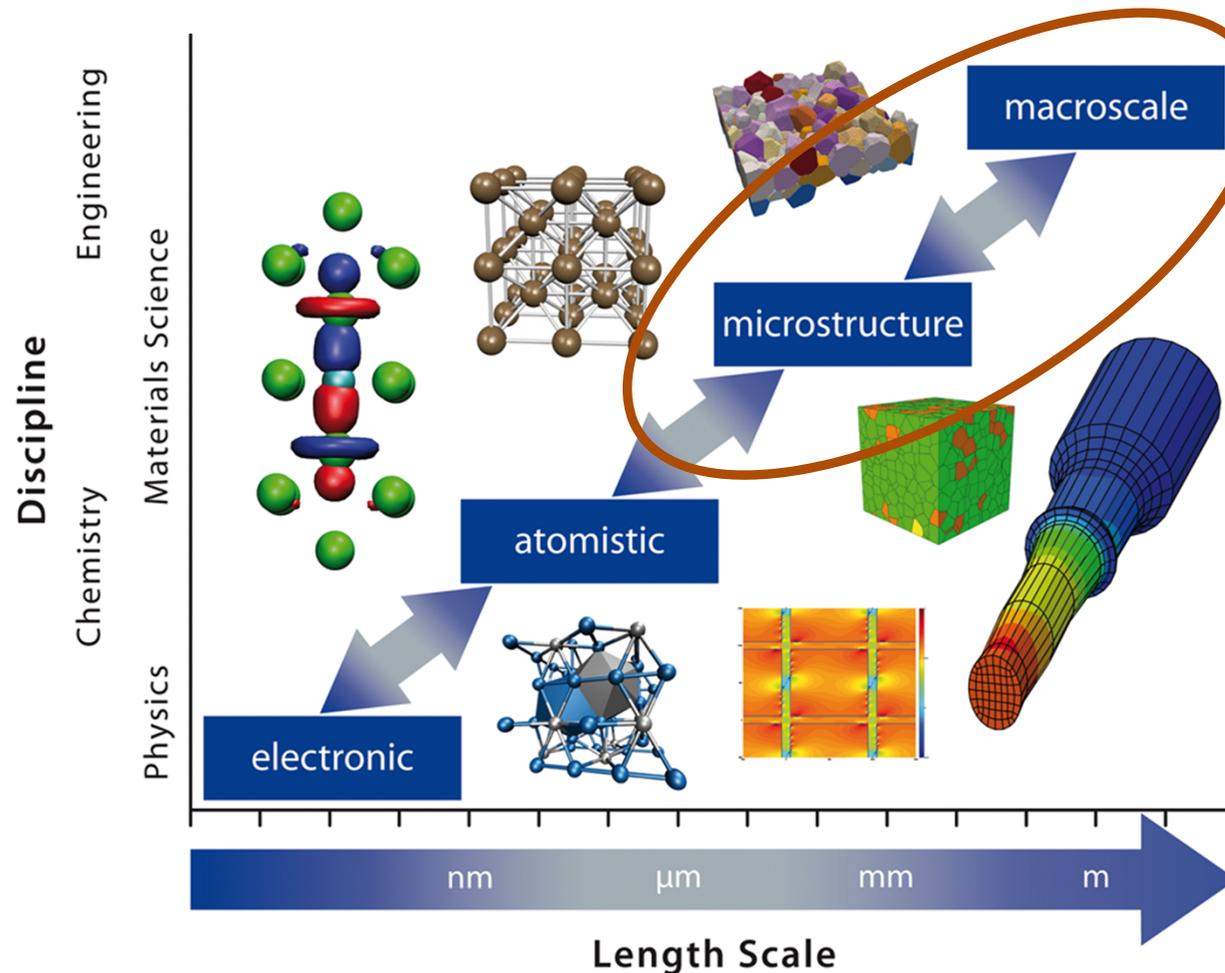


Image source: Zwick (Software)

# Simulation

## Multi-scale simulation



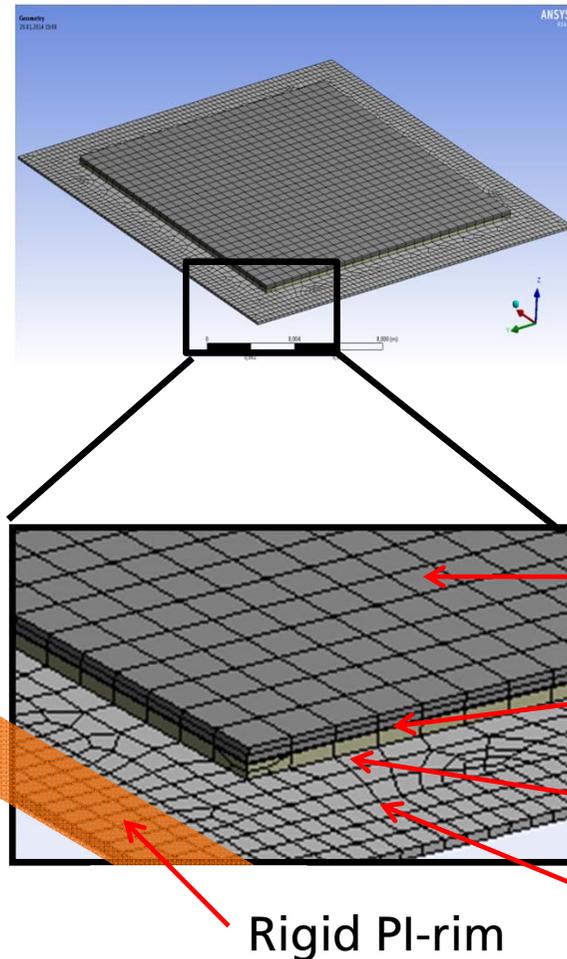
### Macro-scale simulation

- Static Analysis - FEM
- Dynamic processes / vibrations
- Heat transfer
- Flow processes
- Electromagnetism

### Microstructure Simulation

- Friction processes
- Heat conversion
- Dynamic stiffness
- Composite modeling
- New Materials
- Nano / micro-reinforced plastics
- Functionalization

# Meshing of electrode, separator and polyimide layers



- Using material parameters depending on strain
- Estimation of Young's Modulus
- Fitted E modulus found to be 42MPa
- To match the measured actuation force

Upper electrode

Electrolyte separator

Lower electrode

Rigid PI-rim

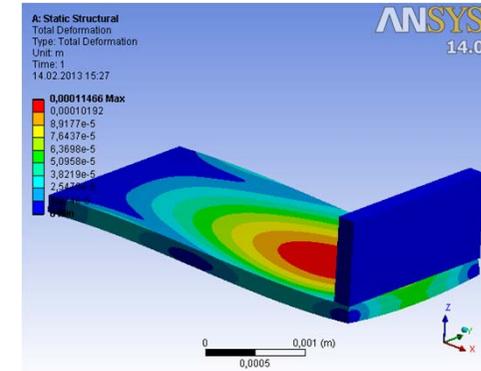
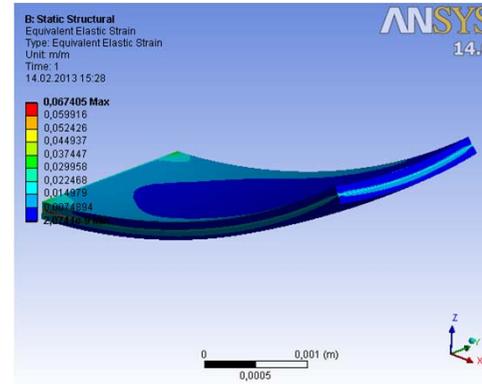
Flexible polyimide layer

# Matching Experimental Data and Linear Elastic Theoretical Model

1) Match effective strain 0.9 % by displacement

2) Match Young's Modulus with force

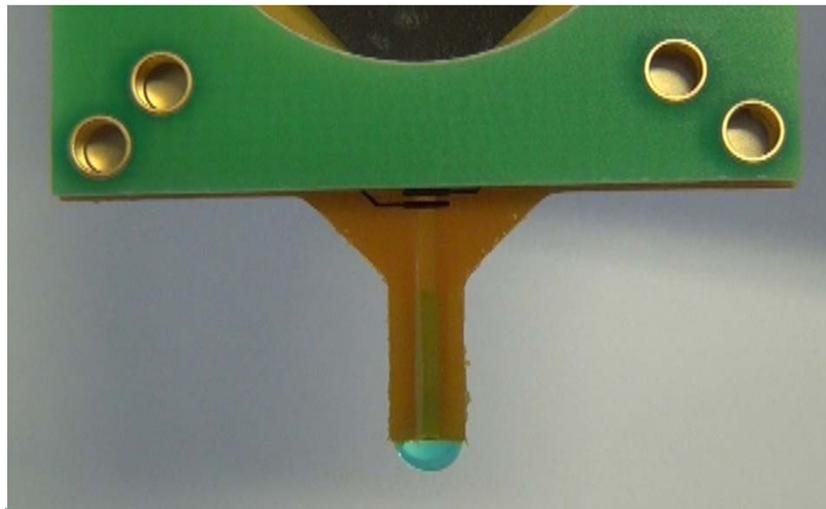
(Poisson's Ratio 0.35; fixed 70 MPa for electrolyte layer)



P2 Electrode Thickness	P6 Actuator Width	P3 Electrolyte Layer Thickness	P4 Young's Modulus	P7 Deformation Probe Z Axis	Corresponding AIST actuator measurement	P1 Force Reaction Z Axis	Corresponding AIST actuator measurement
$\mu\text{m}$	mm	$\mu\text{m}$	MPa	mm	mm	mN	mN
90	2	7.5	350	1.21		22.5	
90	2	7.5	100	1.21		6.5	
105	2	7.5	42	<b>1.06</b>	<b>1.15</b>	<b>3.7</b>	<b>3.87</b>
173	2	7.5	42	<b>0.66</b>	<b>0.53</b>	<b>10.0</b>	<b>9.43</b>

# Actuation Test of Pipette

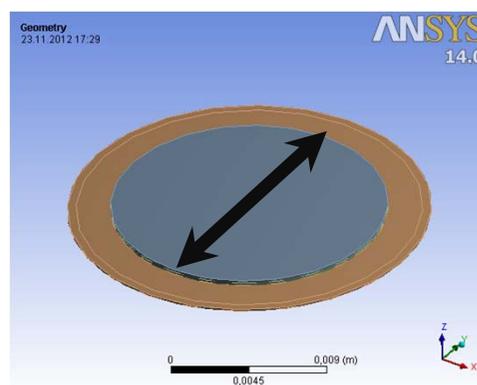
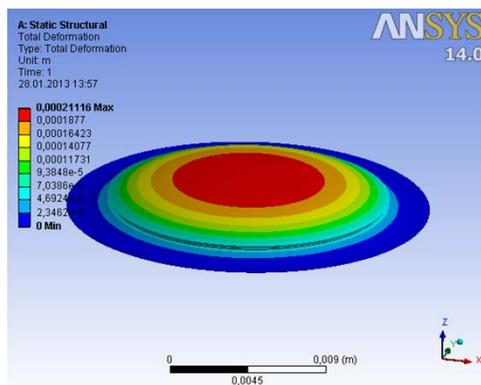
Pipette number	Actuator number	Actuator thickness	Membrane inner radius	Cut to shape	Top electrode connection	Glue	Actuation	Comment
P5	X	323 $\mu\text{m}$	6 mm	no	Counter PCB	Epoxy	70 $\mu\text{m}$	Large droplet
P9	VII	323 $\mu\text{m}$	6 mm	no	Counter PCB	Epoxy	50-70 $\mu\text{m}$	V fast current discharge 0.03A reached in <10sec
P11	V	271 $\mu\text{m}$	7 mm	no	Counter PCB	3M ring type laser cut		Operation tested for fluid level change, small droplet



# Design Space and Parameter Tuning: Open Membrane

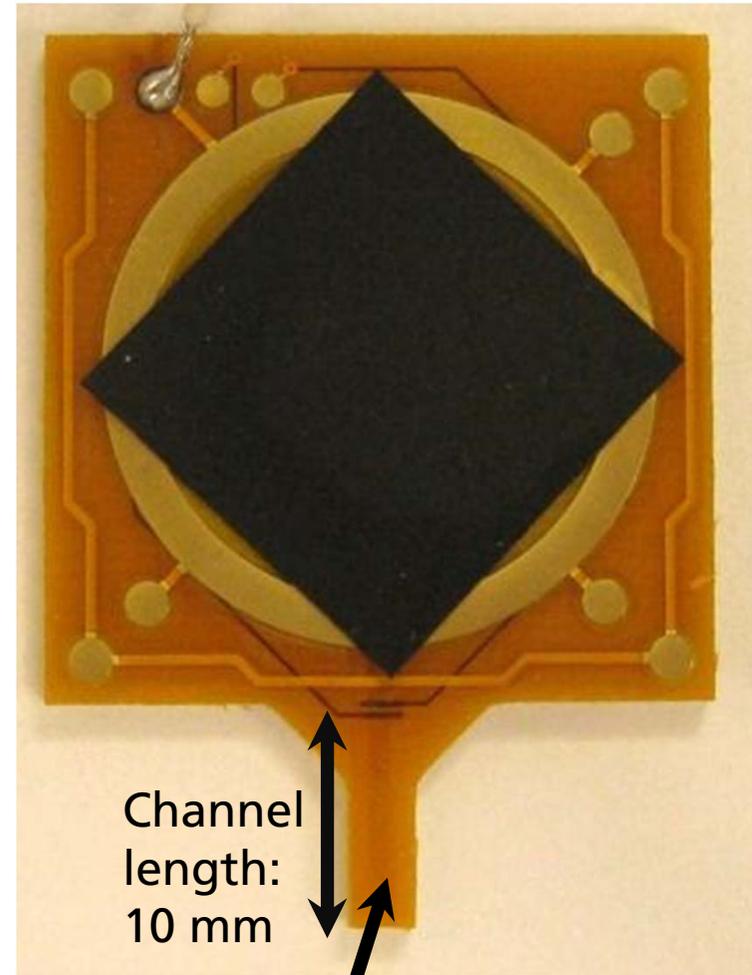
Young's modulus for electrode layer	42 MPa
Young's modulus for electrolyte layer	70 MPa
Flexible layer thickness (passive layer)	0.05 mm
Flexible outer radius	20 mm
Thickness of actuator electrode	150 $\mu\text{m}$
Thickness of electrolyte layer	15 $\mu\text{m}$

Actuator diameter (with 1 mm glue ring)	P7 Deformation Probe Z Axis
mm	$\mu\text{m}$
10	167
12	190
14	208
16	211
18	199



# End result - Pipette Features

- **Fluidic**
  - Nominal fluid and actuation volume 10  $\mu\text{l}$  (up to 20  $\mu\text{l}$  - single droplet)
  - Resistive upper fluid level detection.
- **Electrical specifications**
  - Driving voltage 2 V
  - Capacity 0.23 F
  - Peak current 0.21 A
  - Charging time (10 % to 90 %): 4.1 s

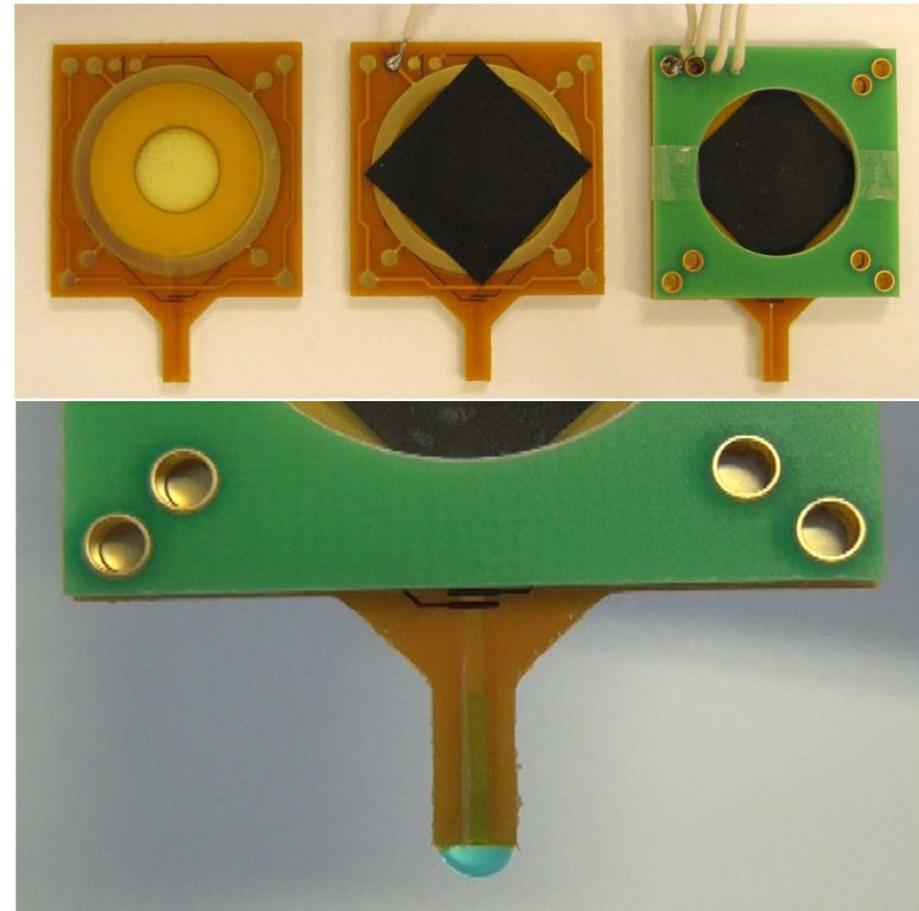


Channel width/height: 1 mm

22

# German-Japanese Cooperation – First Joint Development 2012 –Pipette with CNT actuator

- Simulation of actuation and geometry
- Material development and processing
- Electrical contacting and system integration
- Construction and engineering of Pipette based on PCB board
- Showed at Nanotech 2013



23

# Team Kick-Off Meeting Osaka – March 2013



# Thank you very much for your attention



**Raphael Addinall**  
Department Functional Materials

[Raphael.addinall@ipa.fraunhofer.de](mailto:Raphael.addinall@ipa.fraunhofer.de)

25